

PCBLAYOUT TOP VIEW
TOL ±0.05

NOTES

MATERIAL

- 1.HOUSING MATERIAL: THERMO PLASTICS UL94V-0.
- 2.CONTACT MATERIAL: PHOSPHOR BRONZE T=0.3mm.
- 3.PLATING:GOLD PLATIN ON CONTAC AREA,
TIN PLATING ON SOLER AREA,
NICKEL PLATING ALL OVER.
- 4.SHIELD:0.20mm THICKNESS COPPER ALLOY
WITH NICKEL PLATED.

ELECTRICAL

- 1.VOLTAGE RATING:125 VAC RMS.
- 2.CURRENT RATING:1.5 AMP.
- 3.CONTACT RESISTANCE:40 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE:500 MEGOHMS MIN @ 100V DC .
- 5.DIELECTRIC DIELECTRIC
RESISTANCE:500V DC RMS 50Hz. 1MIN.

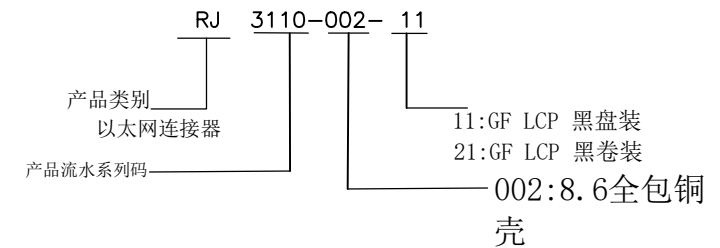
MECHANICAL

- 1.DURRABILITY:750 CYCLES MIN.
2. MATING/UNMATING FORC: 2.24 KG.F MAX.

ENVIRONMENTAL:

- 1.OPERATION: -40℃~+85℃.
- 2.STORAGE: -40℃~+85℃.

8	—
7	—
6	RX-
5	—
4	—
3	RX+
2	TX-
1	TX+
PIN序说明	



UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD			
DECIMALS:		TITLE			
X :±0.30		RJ45沉板8.6 SMT 全铜GF LCP 黑			
X.X :±0.20		DWN	xiong	PART NO. RJ3110-002-11	
X.XX :±0.10		CHKD	lee	SCALE:1:1	UNIT: mm
		APVD	wang	SIZE: A4	SHEET:10F 1
		CUSTOMER COPY			